

ABSTRACT OF THE DISCLOSURE

A process for powder coating comprises forming a coating on a conductive surface or a layer on a conductive surface by applying a powder that is formed by aggregating and coalescing polymer particles in an aqueous dispersion to the surface or layer. A process for powder coating comprises forming a powder by aggregating, in an aqueous dispersion, polymer particles including at least resin particles, coalescing the particles, removing the particles from dispersion and applying the powder to a conductive surface or layer on a conductive surface. A process for forming a powder coating applicator comprises aggregating, in an aqueous dispersion, polymer particles including at least resin particles, coalescing the particles, removing the particles from dispersion and loading the particles into an applicator for use in powder coating. By this process, a powder coating applicator is formed.